



FY2024 Second Quarter

(Fiscal Year Ending March 2025)

FINANCIAL RESULTS BRIEFING

November 24, 2024

日本電子株式会社 JEOL Ltd.



Becoming a top niche company supporting science and technology around the world

COMPANY PHILOSOPHY

On the basis of "Creativity" and "Research and Development," JEOL positively challenges the world's highest technology, thus forever contributing to the progress in both Science and Human Society through its products.

"Evolving in the 70th Year"

Accelerate business expansion and achieve even higher profitability based on our unique technologies and human networks which have been developed since the company's founding.

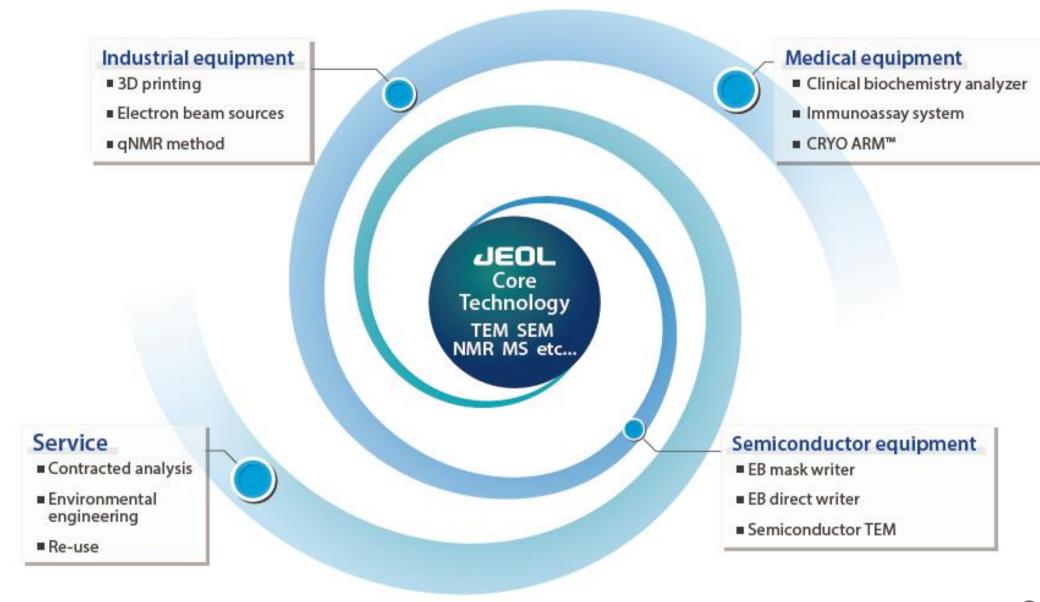
►YOKOGUSHI →
Promote Innovation by co-creation

Mid-term Management Plan "Evolving Growth Plan"

We aim to improve customer satisfaction by strengthening our R&D, manufacturing, and service capabilities.

Growth vision of "Evolving in the 70th Year" remains unchanged

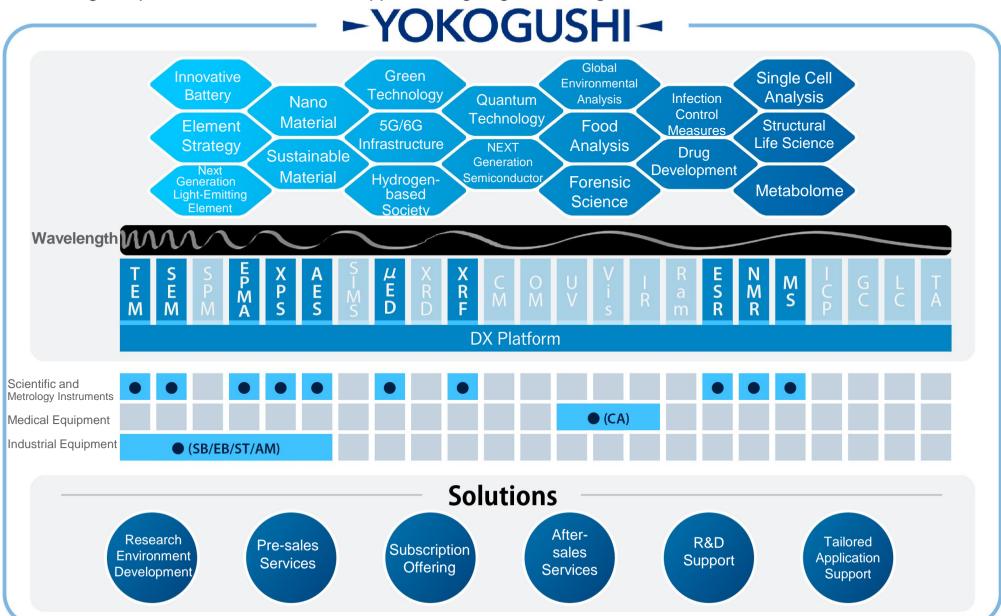
Expand the scale of JEOL business and achieve higher profitability



Strengthen and Develop YOKOGUSHI Strategy



Providing comprehensive solutions that support cutting-edge technologies



Mid-term Management Plan "Evolving Growth Plan" (FY2022-FY2024)

Mid-Term Management Plans since FY 2010

Step 1 (FY10-12)

Improve our business foundation CHALLENGE 5

Management structure reforms

Undertake structural reforms and reduce redundancies Restructure group companies

Corporate culture reforms

Visualization, PDCA, market reforms

Deep cultivation of developing markets

Establish local subsidiaries in Brazil, Russia, India, China and other countries

Step 2 (FY13-15)

Shift toward growth strategies

Dynamic Vision

- Strengthen product developments
- Improve manufacturing abilities
- Enhance our brand power
- YOKOGUSHI strategy fullscale start
- Implement capital policies (public offering & Nikon alliance)
- Convert JRI into consolidated subsidiary

Step 3 (FY16-18)

Concrete growth strategy Triangle Plan

Speed

Pursue high-throughput functionality and speed up development

Difference

Launch unique JEOL products and instill the YOKOGUSHI mindset

Change

Shift focus from academia to industrial customers and from physical products to services

Step 4 (FY19-21)

Accelerate growth and take the next steps

Triangle Plan 2022

- Enhance core technologies
- Proactive entry into growth markets
- Provide total solutions
- Make the required investments and improve profitability

Step 5 (FY22-24)

Expand the business scale and achieve higher profitability

Evolving Growth Plan

- Strengthen and develop YOKOGUSHI strategy
- Build barriers to entry, improve profitability
- Continue to implement new strategies
- Strengthen business support

Net Sales/Operating Profit Transition



(Billion JPY)

Summary

Evolving Growth Plan

Accelerate business scale expansion and achieve higher profitability by further implementing the "Evolving in 70th Year"

FY 2024 1H Results

Highest records were achieved for sales, operating profit, ordinary profit and profits attributable to owners of the parent

Semiconductor Market

Multi-beam mask lithography systems continue to be affected by the slow recovery of the advanced semiconductor investment.

Single beam mask lithography systems continue to see strong demand, mainly from China.

FY2024 Forecast

Net sales196.0 billion JPY, operating profit 33.0 billion JPY ordinary profit 31.5 billion JPY, net profit 23.5 billion JPY

Mid-term Management Plan
Evolving Growth Plan
- Initiatives

- 1. Build barriers to entry and improve profitability
- 2. Expand business in growing markets such as semiconductors, drug discovery, batteries, etc.

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- 2. Business status of each segment
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1. FY2024 2Q result and FY2024 forecast



FY2024 2Q Results (P/L)

Record high for the 1st half of the year

Consolidated figures (P/L)			(100 million JPY	7)
	FY2023 2Q Result (1)	FY2024 2Q Result (2)	Year-on-Year (2) -(1)	Factors for fluctuating ordinary profit (year-on-year)
1 Net sales	687	872	185	(100 million JPY)
2 Sales cost	357	441	85	(A) Positive Factors 101
3 (Cost rate)	(51.9 %)	(50.6 %)	(-1.3 %)	1. Sales volume increase 72
4 Gross profit	330	431	101	2. Exchange margin 29 (yen depreciation)
5 SGA	195	211	17	
	53	61	9	(B) Negative Factors -26
				1. SGA increase -17
7 SGA total	247	273	26	2. R&D cost increase -9
8 Operating profit	83	158	75	
9 Non-operating income	20	7	-13	
10 Non-operating expenses	1	24	23	(A)+(B) 75
11 Ordinary profit	102	141	39	
12 Extraordinary income	2	0	- 2	
13 Extraordinary loss	1	0	- 1	
14 Net profit before tax	102	141	39	
15 Corporate taxes	27	32	5	
16 Net profit	75	109	34	
Exchange rate (1\$=)	¥141	¥152		
Exchange rate (1€=)	¥154	¥165		

Transition of Consolidated Sales & Operating Profit by Segment (Cumulative 2Q)

(100	million	JPY

				(100 111111011 01 1)
		FY2022 2Q result	FY2023 2Q result	FY2024 2Q result
	Net sales	647	687	872
	Operating profit	69	83	158
Company Total	Ordinary profit	88	102	141
	Net profit	72	75	109
Scientific/Metrology	Net sales	358	441	522
Instruments	Operating profit	-1	37	40
Industrial Equipment	Net sales	205	172	287
maddiai Equipmont	Operating profit	93	70	146
	Net sales	85	74	64
Medical Equipment	Operating profit	3	5	4
Company Total	Operating Expenses	26	29	32
Exchange rate(1\$=)		¥133	¥141	¥152
Exchange rate(1€=)		¥139	¥154	¥165

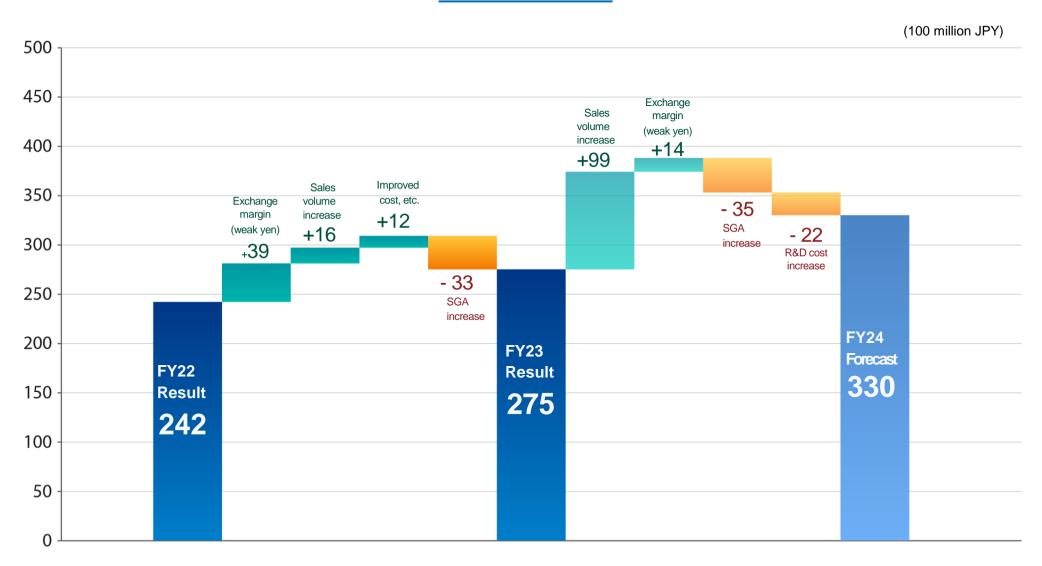
FY2024 Forecast (P/L)

Consolidated net sales ¥196 billion, Operating profit ¥33.0 billion, Ordinary profit ¥31.5 billion, Net profit ¥23.5 billion

Consc	olidated figures (P/L)			((100 million JF	PY)		
		FY23 Full- year Result (1)	FY24 Full- year Forecast (as of May2024)	FY24 Full- year Forecast(2) (as of Nov.2024)	Year-on-Yea (2)-(1)		Factors for fluctuating ord (year-on-year)	linary profit
1 N	et sales	1,743	1,830	1,960	217		(100	million JPY)
	Sales cost	951	972	1,055	104		(A)Positive Factors	112
3	(Cost rate)	(54.5%)	(53.1%)	(53.7%)	(-0.8%)		1.Sales volume increase	99
	ross profit	793	858	905	112		2.Exchange margin (yen depreciation)	14
5	SGA	415	424	450	35			
6	R&D cost	103	134	125	22		(B) Negative Factors	- 57
7	SGA total	518	558	575	57		1. SGA increase	- 35
8 O	perating profit	275	300	330	55		2. R&D cost increase	- 22
	Non-operating income	28	10	10	-18		_	
10	Non-operating expenses	3	5	25	22		(A)+(B)	55
11 O	rdinary profit	300	305	315	15			
12	Extraordinary income	2	2	2	0			
13	Extraordinary loss	8	2	2	-6			
14 Ne	et profit before tax	295	305	318	23			
15	Corporate taxes	78	80	83	5			
16 Ne	et profit	217	225	235	18			
E	xchange rate (1\$=)	¥ 144	¥ 145	¥ 147				
E	xchange rate (1€=)	¥ 157	¥ 158	¥ 161				

Factors Leading to Increase/Decrease in Profits

Ordinary profit analysis



Transition of Consolidated Sales & Operating Profit by Segment (Full-year)

(100 million JPY)

		FY2022 Full- year result	FY2023 Full- year result	FY2024 Full-year Forecast (as of May 2024)	FY2024 Full-year Forecast (as of Nov. 2024)
	Net sales	1,627	1,743	1,830	1,960
Company Total	Operating profit	242	275	300	330
Company Total	Ordinary profit	235	300	305	315
	Net profit	178	217	225	235
Scientific/Metrology Instruments	Net sales Operating profit	948 58	1,200 168	1,176 168	1,278 161
Industrial Equipment	Net sales	495	390	497	530
industrial Equipment	Operating profit	233	162	189	228
Medical Equipment	Net sales Operating Profit	184 5	153 5	157 5	152 5
Company Total	Expense	54	60	62	63
Exchange rate(1\$=)		¥ 135	¥ 144	¥ 145	¥ 147
Exchange rate(1€=)		¥ 141	¥ 157	¥ 158	¥ 161

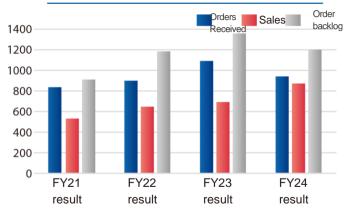
Transition of Major Accounts

2nd Quarter

(100 million JPY)

(Consolidated)	FY2022 2Q result	FY2023 2Q result	FY2024 2Q result
1 Inventory	706	821	822
2 Interest-bearing debt	140	90	108
Net assets (capital-to-asset)	927 (49.0%)	1,094 (53.4%)	1,316 (57.3%)
4 Dividend (JPY)	30 JPY	33 JPY	44 JPY
5 Overseas sales ratio	75.4%	66.7%	76.4%
6 Consolidated Orders received	899	1,092	941
7 Consolidated Order Backlog	1,187	1,361	1,203

2Q Transition of Consolidated Orders, Sales and Backlog



Full-year (100 million JPY)

	consolidated)	result		FY2024 Full-year forecast
1	Inventory	688	768	740
2	Interest- bearing debt	115	145	91
3	Total assets	1,993	2,302	2,170
4	Net assets (capital-to-asset)	1,019 (51%)	1,255 (55%)	1,420 (65%)
5	Dividend(JPY)	66 JPY	102 JPY*	92 JPY
6	Capital investment	37	56	50
7	Depreciation cost	47	47	50
8	Consolidated Ordereceived	rs 1,647	1,922	1,830
9	Consolidated Order backlog	956	1,135	1,005
10	Oversea sales ratio	70.7%	65.4%	70.0%

^{*} Includes a commemorative dividend of 20 JPY for the 75th anniversary of the company

Capital Efficiency Indicators

1 ROE	19.0%	19.1%	17.6%
2 ROIC	16.7%	15.9%	15.0%
3 PBR	X 2.1	X 2.6	_

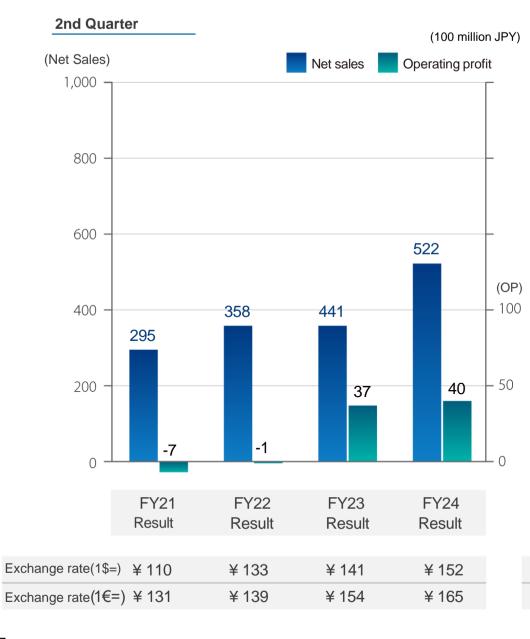
Business Environment

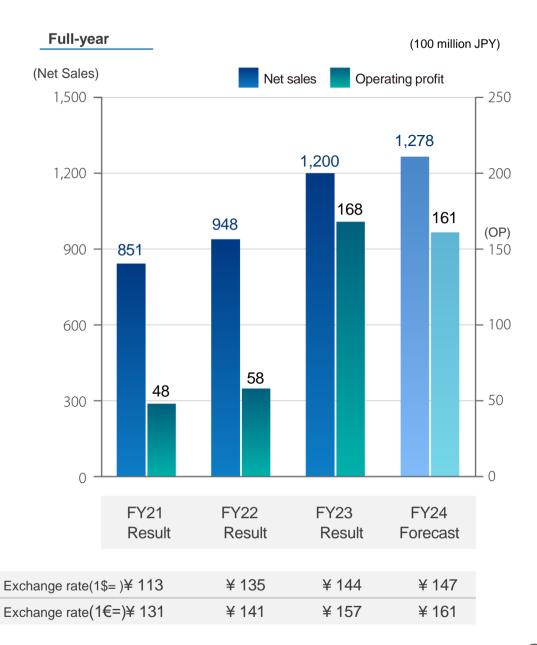
 Scientific and Metrology Instruments orders continue to be strong. Advanced semiconductor market continues to be in an adjustment phase

			Overview
Scientific	Universities and Governmental Demand	(Good)	■ Governmental investment in science and technology is strong However, in China, supplementary budgets for low-interest loan policies have run their course
and Metrology	Private Demand (Semiconductor)	(Good)	■ Demand continues to be brisk, especially in South Korea and Taiwan
Instruments	Private Demand (Other industries)	(Good)	■ R&D investments continue in the battery market
Industrial Equipment	Lithography System Market	O (Good)	 Multi-beam mask writer market saw a delay in the recovery of EUV investments. Future full-scale recovery is expected Single beam mask writer demand continues to be brisk, mainly in China Spot beam continues to be strong
	EB Source Market	(Slow)	■ EB source market continues to be weak
Medical	Japan	(Good)	■ Demand continues to be strong, mainly for test centers
Equipment	Overseas Market	(Slow)	■Orders and sales continue to decrease due to the impact of the "Buy China" policy

2. Business status of each segment2-1. Scientific/Metrology Instruments







Scientific and Metrology Instruments

Continue efforts for profit enhancement through further development of Scientific and Metrology Instruments

1

Expansion in overseas markets

 Growth in overseas markets, especially of electron microscopes, is expected.



3

Development of differentiated products

- World-leading technology proven by track record in academia research of cuttingedge technologies
- Development of innovative products



Profit

Enhancement

 Further JEOL technology adoption for commercial applications, such as Applied R&D and QA / QC



- Increase services business from overseas customers
- Provide innovative service products



2

Expansion in the private sectors

4

Improvement of service business acquisition rate

Solutions in semiconductor market by our scientific and metrology instruments

- Semiconductors are fundamental technologies for everything
- Developing technologies that can solve social issues requires legacy to cutting edge semiconductors

Semiconductor Technologies

Development of next-generation semiconductor

- New structure transistor development
- New material development
- Advanced packaging technology development

Production technologies for semiconductor

- High yield stabilization technology
- Market defect rate reduction technology
- Clarification of failure//defect mechanism

Solution provided by JEOL

Semiconductor structure measurement (Optimization of production condition)

 Preparation of very thin membrane TEM specimen by FIB and measurement of its thickness, high throughput and automation of shape observation



JEM-PS500i

JEM-ACE200F

Analysis to improve yield/reliability

- Morphological observation of defective specimen/membrane thickness measurement by TEM, composition analysis (EDS), bonding state measurement (EELS), micro volume analysis, damageless measurement, high resolution observation(interface, grain boundaries)
- Observation and analysis of defective specimen by SEM, identification of defective areas



NEOARM

JSM-IT810

Electronic state measurement of materials

Measurement of material band gap/defect level/bonding state

The needs for sophisticated analysis system has increased due to miniaturization of semiconductor and progress in layering





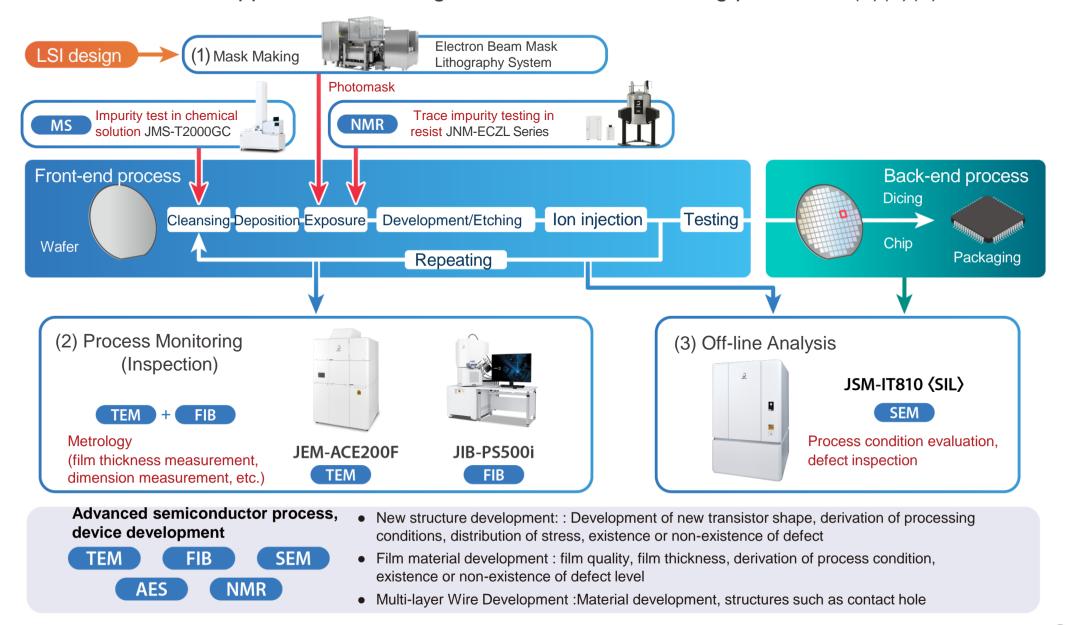






Solutions for Semiconductor Manufacturing Processes

Growth opportunities in integrated circuit manufacturing processes (1)(2)(3)



JEOL-Taiwan Advanced Semiconductor Solution Center (JTASC) established

■ JEOL-Taiwan Advanced Semiconductor Solution Center (JTASC) is established in Zhubei City, Hsinchu Country, Taiwan to provide more fulfilling total solution to contribute to further development of the semiconductor industry in Taiwan.





President & CEO Izumi Oi at JTASC Opening Ceremony

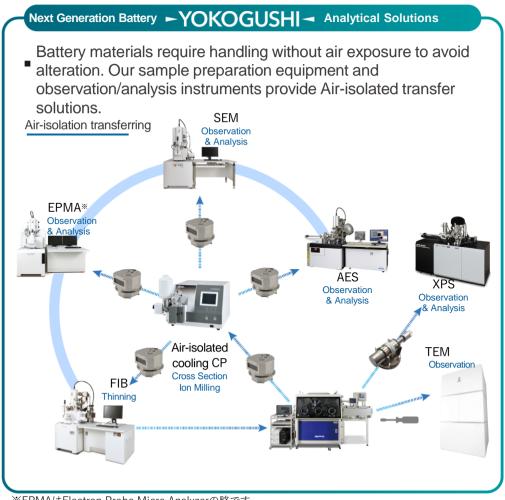


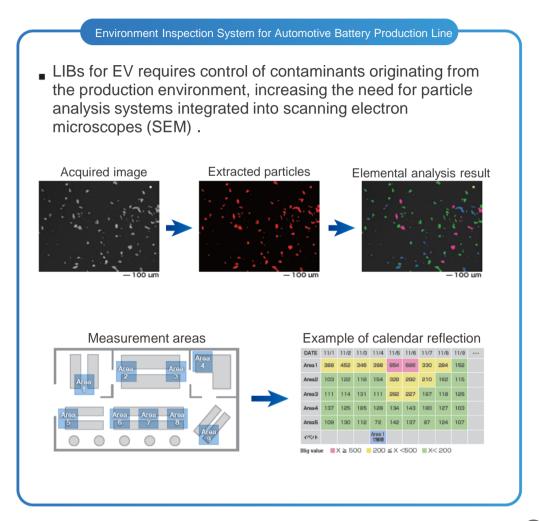
JEM-ACE200F
High Throughput Analytical
Electron Microscope

JIB-PS500i FIB-SEM System

Analytical/Testing Solutions for the Next Generation Battery Technologies

- Batteries contain lithium and sulfur which must be handled without exposure to air to avoid oxidation. Our metrology, analytical, and sample preparation products provide an air-isolation transfer solution.
 - In addition to R&D for next-generation batteries, contamination control in the manufacturing environment is also required.
- The need for Particle Contamination Inspection (PCI) systems based on Scanning Electron Microscopy (SEM) is increasing.
- Strong demands continues.

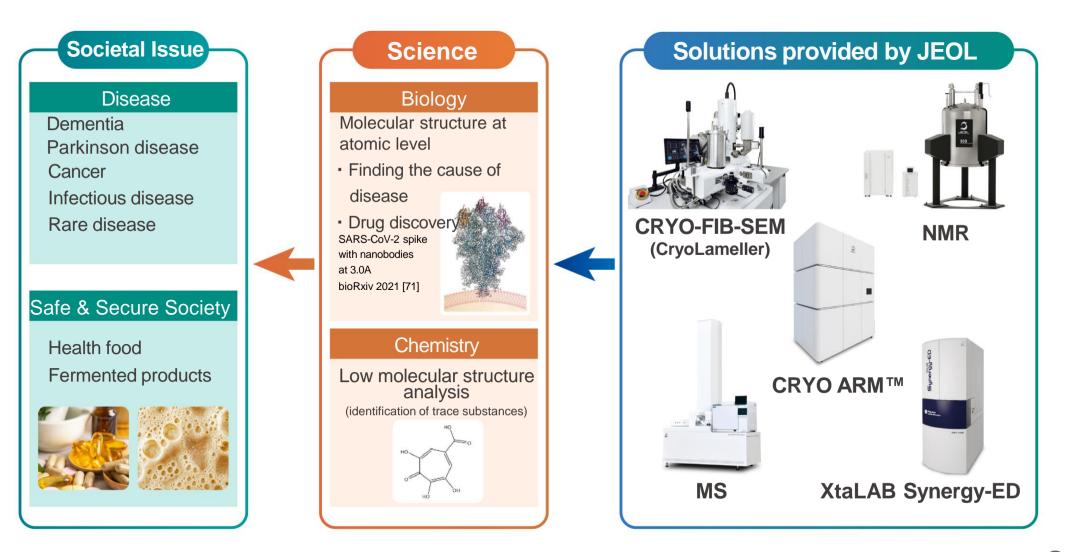




Solutions for the Life Science market

Develop products and solutions for structural biology (observation of molecules at the atomic level)
 that will solve societal issues.

JEOL's approach to problem solving



JEOL Growth Opportunities in the Life Science Market

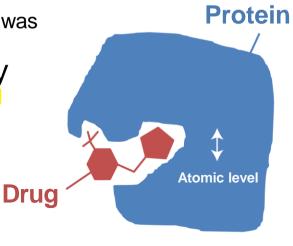
 Cryo-electron microscopes (TEM) and nuclear magnetic resonance spectrometers (NMR) are invaluable tools for the analysis of proteins at the atomic level.

The drug is a key designed to fit a protein's lock

Classical drug discovery before 1990 was

centered on Chemistry

Nobel Prize 1915 X-ray crystallography 1952 NMR Signal



Current drug discovery

Utilizes Structural Biology

Nobel Prize
1962 Protein X-Rays
2002 NMR of Biomacromolecules, MS of proteins
2017 Cryo-electron microscopy of biopolymers

Acquisition of Japan Superconductor Technology Inc. ("JASTEC")

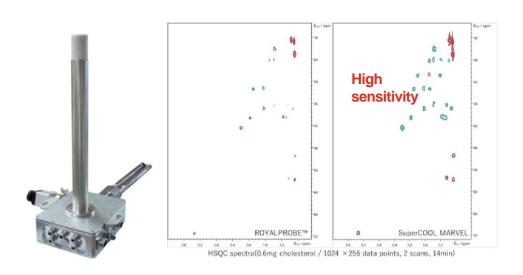
- JEOL Ltd. and Kobe Steel, Ltd. agreed to acquire all shares of Japan Superconductor Technology Inc. ("JASTEC") and make JASTEC a subsidiary of JEOL Ltd.
- Since its establishment, JASTEC has been engaged in the manufacture and sales of superconducting wires and magnets, and is an important supplier of magnets, which are the major components of the NMR spectrometer (NMR: Nuclear Magnetic Resonance), one of the main products in our Scientific and Metrology Instruments business.
 By making the company a subsidiary, we will further strengthen our development and production systems and product competitiveness.
- Date of share transfer: Early January 2025 (scheduled)

JASTEC	Outline					
	Name	Japan Superconduc	tor Technology Inc.			
	Address	1-5-5 Takatsukadai,	Nishi-ku, Kobe, Hyogo)		
_	Company representative	CEO Takahiro Anai				
	Business description		f superconducting wire	es & magnets	8	
3	Capital	400 million yen (as o	of March 31, 2024)			JEOL
JASTEC	Established Date	April 1, 2002				500
SUPERCONDUCTOR	Shareholders & ratio	Kobe Steel, Ltd.	85.1%			_
		JEOL Ltd.	14.9%		<u> </u>	
	Sales	410 million yen (yea	r ending March 2023)		10001	
				g	0 0 0 0	
				-11		

New Product "SuperCOOL MARVEL" High Sensitivity Cooling Probe (for NMR) (Launched in July 2024)

- Extremely useful for measurement of samples that decompose or change quickly, or of trace samples that are difficult to obtain.
- Sensitivity improved by more than two-times that of our conventional NMR ROYAL ProbeTM)

SuperCOOL MARVEL



■ SuperCOOL MARVEL is the 4th generation probe of Super COOL Probe series launched in 2013.

ROYAL Probe™

■ SuperCOOL MARVEL is a multi-nuclear probe capable of measuring not only basic nuclei such as 1H and 13C, but also 19F and 31P nuclei.

SuperCOOL MARVEL Feature

1. High sensitivity

- This product has more than doubled the sensitivity of our representative solution probe, the ROYALPROBE™
- In NMR, doubling the sensitivity means that the number of integrations required to achieve the same signal intensity is reduced to one-quarter. SuperCOOL MARVEL can achieve the same results in a shorter time than ever before, significantly improving throughput.

vs ROYALPROBE™, example of 400~600MHz

Nuclei	Ratio of sensitivity	Required integration ratio
¹ H	ca. X 2	ca.1/4
19 F	ca. X 2.1	ca.1/4
31 P	ca. X 3.2	ca.1/10
13 C	ca. X 2.6	ca.1/7

2. Open cooling system

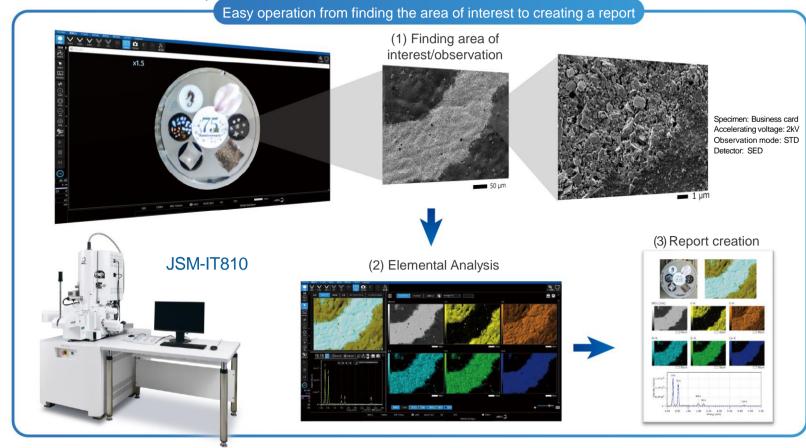
- By adopting an open cooling system, and by using liquid nitrogen, both the probe coil and preamplifier are cooled.
- Refilling liquid nitrogen is possible during measurement and enables seamless measurement without interruption for coolant refilling.

New Product "JSM-IT810" Schottky Field Emission Scanning Electron Microscope

(Launched in July 2024)

- Field Emission Scanning Electron Microscopes (FE-SEM) are widely used in science and technology fields such as research institutes, universities, and industry. There is a growing demand for an instrument that can be used easily, accurately, quickly, and efficiently from observation to analysis.
- The JSM-IT810 is equipped with the next-generation electron optical control system "Neo Engine", the "Zeromag" that seamlessly connects optical and SEM image, the "SEM Center" for high operability such as EDS integration, as well as automatic observation and analysis function "Neo Action" and automatic calibration function, to improve operability and productivity.

■ The version JSM-IT810 (SIL) equipped with a semi-in lens offers superior performance in semiconductor physical analysis, including potential contrast observation, which is essential for semiconductor device failure analysis, and high-resolution observation of tilted and cross-sectional samples.





New Product "IB-19540CP/IB-19550CCP" Cross Section Polisher™

(Launched in September 2024)

- The Cross Section Polisher™ IB-19540CP/Cooled Cross Section Polisher™ IB-19550CCP is a new cross-section preparation device for electron microscope that enables easy preparation of good cross sections of composite materials and brittle samples without mechanical distortion.
- The new GUI and IoT make it easy to operate, and the increased ion beam current density improves throughput.
- The Cross Section Polisher™ (CP) is widely used in the fields of electronic components, ceramics, metals, batteries, polymers, and life sciences.



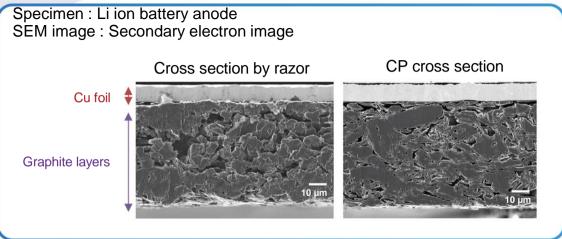
Specimen: Au coating of electronic parts
SEM image: Backscattered electron image

Machine-polished surface

Polishing mark
Abrasive
grains

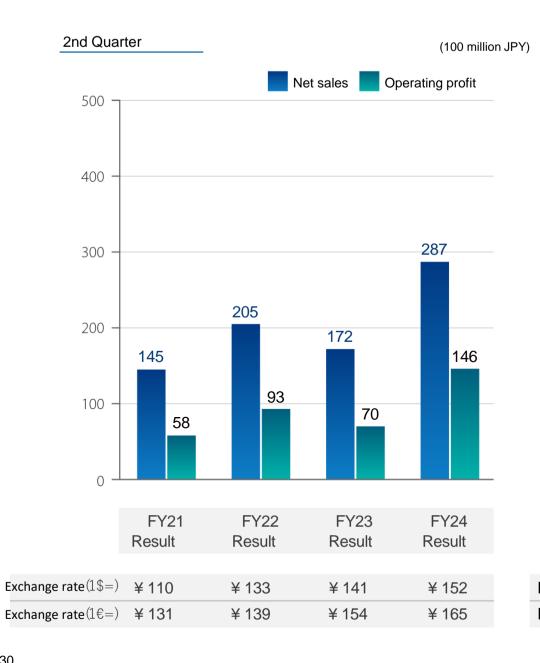
CP cross section

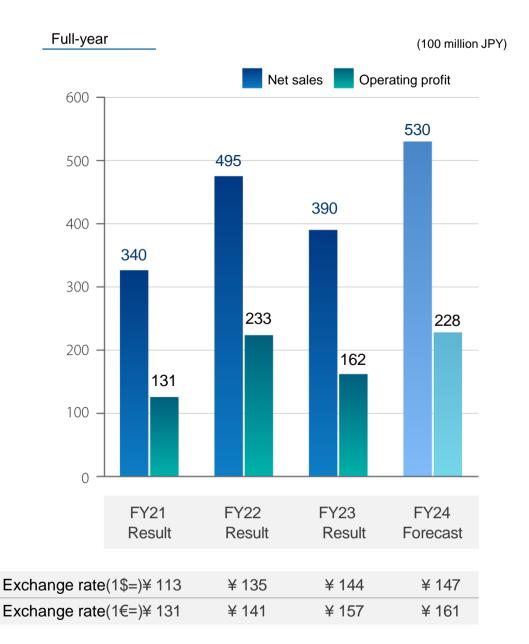
NiP



2. Business status of each segment2-2. Industrial Equipment

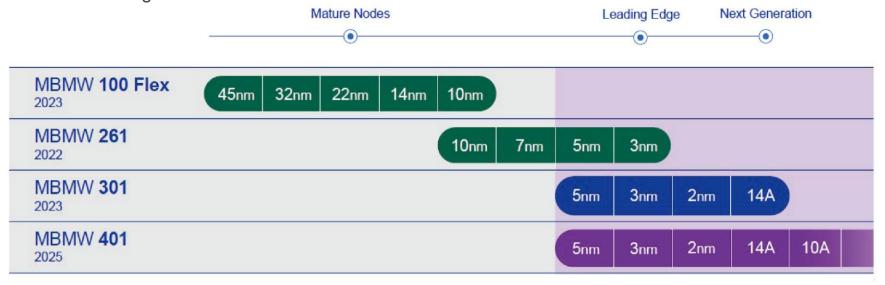






Multi-beam Mask Writer Development Roadmap and MBMW-401

- Maintain and expand our competitive advantage by continuing to improve performance and functionality in parallel
 with the continued miniaturization of semiconductor devices
- Growth opportunities: Increased the number of EUV layers, application to some DUV masks due to growing needs for curve-liner drawing





Electron Beam Mask Lithography System

- Single beam mask lithography systems for legacy nodes continue to be strong mainly in China.
- Supports mask-making from cutting edge node to legacy node area with our multi-beam mask lithography systems and single beam lithography systems



Spot type Electron Beam Lithography System

Optical transceivers with intensity modulation are widely used in data centers and many DFB laser chips are installed as a single wavelength, high power light source. The demand for Spot Beam system is increasing due to increased DFB production.





JBX-8100FS

Electron Beam Lithography System

JBX-A9

Electron Beam Lithography System

Electron Beam Metal 3D Printer

- Sales promotion activities are ongoing, centered on each sales base (Japan, USA, Germany)
- Increased inquiries from domestic and overseas customers

Advantages of electron beam metal 3D printer

Printer

Mass production by stacking

Preheating function suppresses cracking and deformation, enabling mass production of models stacked in height direction



Material: Ti64

Builds: Hip cup (artificial hip joint)

Melting point 3,420°C / Φ65mm×55mm(H)

Molding of high melting point metals

In addition to high thermal energy, high-performance heat shielding enables large tungsten molding





Material: Tungsten

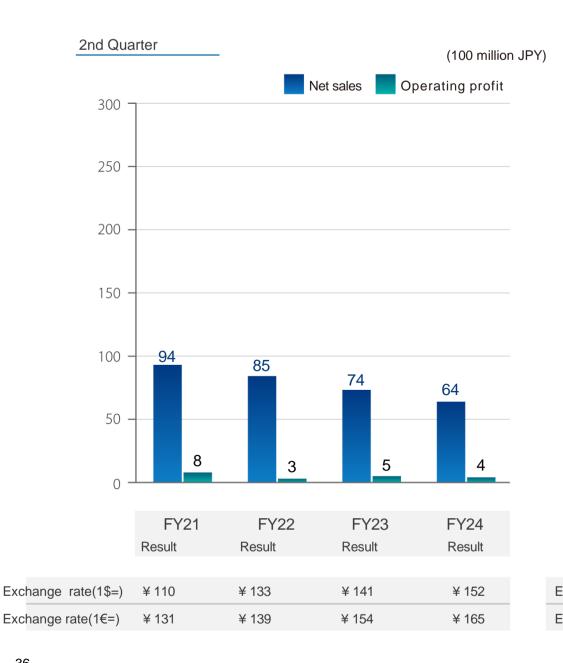
Builds: Heat exchange parts for radiation shields

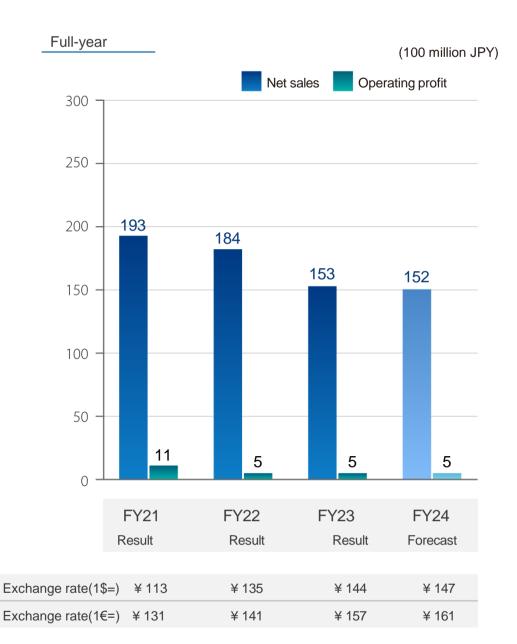


2. Business status of each segment

2-3. Medical Equipment







Medical Equipment: Clinical Chemistry Analyzer

- Inquires and orders are strong mainly for test centers in Japan
- Aim to re-establish overseas sales strategy with the competitive products







*BioMajesty" is a registered trademark of JEOL Ltd.

Feature of JEOL Equipment

Micro volume sample & reagent / High-throughput

3. Summary





Becoming a niche top company supporting science and technology in the world

Company Philosophy

On the basis of "Creativity" and "Research and Development", JEOL positively challenges the world's highest technology, thus forever contributing to the progress in both Science and Human Society through its products.

Vision

"Evolving in the 70th Year"

Accelerate business expansion and achieve even higher profitability based on our unique technologies and human networks which have been developed since the company's founding.



Mid-Term Management Plan "Evolving Growth Plan"

We aim to improve customer satisfaction by enhancing our R&D, manufacturing, and service capabilities.

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